

B1
cont. wherein L_1 represents a fiber length of magnetic fibrous filler (A), D represents a thickness of composite sheet, and L_2 represents a minimum distance between neighboring electrodes among neighboring-electrode distances with respect to electrodes arranged on a semiconductor element on its composite sheet side or neighboring-electrode distances with respect to electrodes arranged on a circuit substrate on its composite sheet side, and

wherein the magnetic fibrous filler (A) is a fibrous filler having both conductivity and magnetism.

[Please add the following new Claim 57:]

57. (New) The method as claimed in claim 56, wherein the composite sheet is produced by a process comprising the steps of:

B2 sheeting a composition into a sheet of given thickness, said composition comprising a fibrous filler having both conductivity and magnetism and a thermosetting and/or photocuring binder (B), and

not only applying a magnetic field to the composition sheet in the direction of the thickness of the composition sheet so as to orientate the fibrous filler having both conductivity and magnetism in the direction of the thickness of the composition sheet but also curing the binder (B) by heating and/or light irradiation.

DISCUSSION OF THE AMENDMENT

Claim 56 has been amended to, in effect, depend on Claim 49 only. New Claim 57 has been added, and is, in effect, original Claim 56 but dependent on Claim 50 only.

No new matter has been added by the above amendment. Claims 12, 13, 18-26, 30-38, 47 and 56-57 are now active; Claims 1-11, 14-17, 27-29, 39-46 and 48-55 stand withdrawn from consideration.